single transparent substrate. Circuit substrates in which driver circuits for supplying signals to signal and scanning electrodes of the elements are mounted are bonded to the elements. The circuit substrate has an end-sealing property and through-holes bored opposite the signal and scanning electrodes. The through-holes are covered by a conductive, end-sealing material. Signals are supplied from the driver circuit to the signal and scanning electrodes through the conductive material. A portion of the organic EL element which is not bonded to the circuit substrate is covered by an end-sealing material.--

## IN THE CLAIMS

Please amend claims 1, 2, and 4-9 by rewriting same to read as follows, cancel claim 3, without prejudice or disclaimer, and add new claim 10.

- --1. (Amended) A direct-view-type display apparatus comprising
- a plurality of individual display elements placed on a single transparent substrate, each of said plurality of display elements having a plurality of signal electrodes and scanning electrodes in a matrix form with a light-emitting element at each intersection of the matrix, wherein a space between adjacent ones of said display elements is equal to a space between a signal electrode and a scanning electrode, such that each of said plurality of display elements forms a separate pattern; and
  - a plurality of drive circuits provided in correspondence

to said plurality of display elements being mounted respectively on a plurality of circuit substrates for supplying signals to said plurality of signal electrodes and scanning electrodes of said plurality display elements.

- --2. (Amended) The direct-view-type display apparatus according to claim 1, wherein said transparent substrate is a film-like substrate.
- --4. (Amended) The direct-view-type display apparatus according to claim 10, wherein said transparent substrate is a film-like substrate.
- --5. (Amended) The direct-view-type display apparatus according to claim 1, wherein

said plurality of circuit substrates are covered with an elastic material.

--6. (Amended) The direct-view-type display apparatus according to claim 1, wherein: each of said plurality of display elements is an organic EL element; a height of a signal electrode and a height of a scanning electrode of said organic EL element on said transparent substrate are substantially equal; said circuit substrate is made of a material having a sealing property and has through-holes bored at positions opposing said signal electrode and said scanning electrode; said through-holes are covered by a conductive material having a sealing property; said circuit substrate is

closely joined to said organic EL element such that said through-holes are opposed to said signal electrode and said scanning electrode; said drive circuit supplies a signal to said signal electrode and said scanning electrode through said conductive material having a sealing property and said organic EL element is covered at a portion that is not jointed to said circuit substrate with a sealing material.

- --7. (Amended) The direct-view-type display apparatus according to claim 6, wherein each of said plurality of circuit substrates is a film-like substrate.
- --8. (Amended) The direct-view-type display apparatus according to claim 6, wherein a side surface of each of said plurality of circuit substrates is covered with an elastic material.
- --9. (Amended) The direct-view-type display apparatus according to claim 7, wherein a side surface of each of said plurality of circuit substrates is covered with an elastic material.
- --10. (New) A direct-view-type display apparatus comprising:
- a plurality of individual display elements placedon a single transparent substrate, each of said plurality of display elements having a plurality of signal electrodes and a plurality of scanning electrodes in a matrix form with a